## **INFORMATION NOTE**



N° 109/16

Dear Customer,

With this INFINEON Technologies Information Note we would like to inform you about the following

Data sheet update affecting product TLE5012BD

Infineon Technologies AG
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Chairman of the Supervisory Board: Wolfgang Mayrhuber
Management Board: Dr. Reinhard Ploss (CEO), Dominik Asam, Dr. Helmut Gassel, Jochen Hanebeck
Registered Office: Neubiberg Commercial Register
Amtsgericht München HRB 126492

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## **INFORMATION NOTE**



#### N° 109/16

### Data sheet update affecting product TLE5012BD

<b>&gt;</b>		Sales Name	SP N°	OPN	Package
		TLE5012BD E1200	SP001205296	TLE5012BDE1200XUMA1	PG-TDSO-16-2
		TLE5012BD E9200	SP001205300	TLE5012BDE9200XUMA1	PG-TDSO-16-2

#### **▶** Detailed Change Information:

Subject:	Data sheet update affecting product TLE5012BD		
Reason:	- Additional information given on the ESD protection for HBM and CDM		
	- Correction of Marking information		
	<ul> <li>Package information update with improved chip placement tolerances</li> </ul>		

Description: Old		<u>1</u>	New	
	■ Datasheet Rev. 1.0	•	<ul> <li>Datasheet Rev 1.2 (for details refer to 4_cip16109 attached)</li> </ul>	

► Product Identification:	Not applicable; data sheet update introduced only.

<b>&gt;</b>	Impact of Change:	No change neither of product nor process.
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► Attachments:	Datasheet Rev. 1.2: 4_cip16109		

# Intended start of delivery:

Valid with immediate effect.

If you have any questions, please do not hesitate to contact your local Sales office.

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